

Passivation Species Suppress Atom-by-Atom Wear of Microcrystalline Diamond

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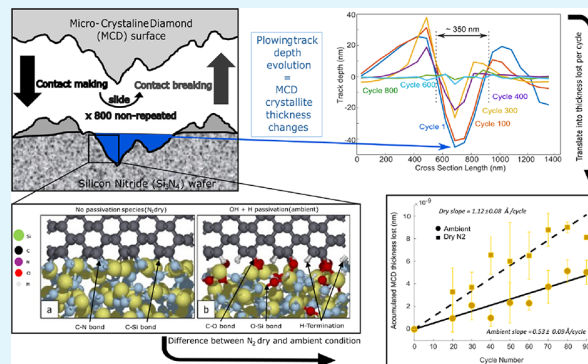
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ABSTRACT: Despite its supreme hardness, (synthetic) diamond wears. Due to the small volume loss involved, diamond wear is challenging to quantify, specifically for multicontact interfaces. Consequently, identifying which wear mechanisms dominate the degradation of macroscopically loaded diamond interfaces has remained an open challenge. Using a topography difference method based on atomic force microscopy imaging, we observe the wear of multi-asperity microcrystalline diamond (MCD) surfaces sliding nonrepeatedly against silicon nitride (Si_3N_4)-coated silicon wafers. By examining the wear scars on Si_3N_4 , which can be seen as footprints of the MCD surface, we are uniquely able to track the nanoscale wear of individual MCD crystallites. Our MCD wear measurements show that the diamond wears atom-by-atom and that this wear is accelerated in the absence of passivation species in the environment. This conclusion is confirmed by ab initio molecular dynamics simulations, highlighting how diamond surface passivation suppresses interfacial bonding. Our results thus demonstrate that atom-by-atom wear occurs even in realistic, multi-asperity diamond contacts and that environmental passivation provides a practical and effective means to control interfacial degradation in advanced tribological systems.

KEYWORDS: tribochemical wear, passivation species, plowing friction, nonrepeated wear, diamond, multi-asperity contact



INTRODUCTION

Surfaces subject to contact and friction break down and need replacement: the wear of materials has been estimated to cost 4% of the gross domestic product in industrialized nations.^{1–3} Synthetic diamond coatings have attracted significant attention because such coatings can offer high wear resistance under harsh contact conditions,⁴ making it possible for applications subject to tribological contact to last longer before requiring replacement. For example, synthetic diamond has found application in cutting tools, drills, bearings, and micro-electromechanical systems (MEMS).^{5–9} Arguably, the most stringent requirements in terms of wear can be found in the semiconductor industry, where nanometer-scale patterning requires subnanometer-scale control over the positioning of, i.e., silicon (Si) wafers. This means that the smallest amounts of wear can already be significant, necessitating an understanding of the diamond wear process down to the smallest of length scales.

The mechanisms behind the nanoscale wear of diamond are debated. Both computer simulations^{10–12} and atomic force microscopy (AFM) experiments^{13–15} have demonstrated that diamond surfaces can wear in an atom-by-atom wear process.^{16–21} In this atomic attrition wear, covalent bonds are formed between the carbon atoms on the diamond surface and, i.e., silicon or oxygen atoms on the counter surface as a

first step toward carbon removal.^{22,23} Theoretical studies have indicated that the diamond C(110) surface, specifically, is susceptible to tribochemical wear of zigzag carbon chains,¹¹ while the wear can be suppressed through surface passivation,²⁴ for example, with hydrogen^{25,26} which then blocks the bond formation with the counter surface. Furthermore, graphitization and amorphization^{27–30} of the topmost diamond have been reported.

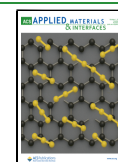
As an alternative to the atomic attrition of the topmost diamond, it has been suggested that diamond wear may dominantly take place through a fracture process^{31–33} in which cracks propagate into the diamond matrix such that clusters of carbon atoms—or complete crystallites—can be removed from the diamond surface.^{34,35} In single asperity AFM experiments with high contact pressures, such fracture and detachment of atom clusters have been observed.^{15,34,36} Furthermore, multi-asperity contacts can contain even larger contact patches,

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thereby surpassing the critical scale for adhesive wear and promoting crack formation.³²

The observation and prediction of these differing diamond wear mechanisms raise a key question for the application of diamond in larger contacts: how will industrially representative diamond multicontacts wear? While fracture-induced wear mechanisms are thought to become more dominant as contacts scale up,^{32,35} such large scales remain challenging to investigate with accurate simulations in which the system size is limited. Furthermore, it is highly challenging experimentally to characterize and quantify the wear³⁷ of diamond multicontacts, because the wear volumes are orders of magnitude smaller than the size of the system. Consequently, there remains a large gap between the theoretical understanding of diamond wear at the atomic scale and the experimental observations of diamond wear in multiasperity contacts.

To address these challenges and to link all the way from fundamental insights at the atomic scale to industrially relevant multicontact³⁸ interfaces, we investigate the wear behavior of microcrystalline diamond (MCD) coatings interfaced with Si₃N₄ wafers. Through a combination of ab initio molecular dynamics (AIMD) and unique, precision wear experiments supplemented by ex-situ AFM characterization,³⁹ we show that diamond multi-contacts wear through atomic attrition in which the presence of passivation species plays a key role.

EXPERIMENTAL AND COMPUTATIONAL METHODS

Silicon carbide (SiC) spheres (DitHolland, 3 mm diameter) were coated with a 1 μm thick MCD layer (Fraunhofer Institute for Surface Engineering and Thin Films). Si wafers (University wafer) coated with a 100 nm thick Si₃N₄ layer (amorphous, grown with the LPCVD method) were used as the counter surface. The mechanical properties of Si₃N₄ and MCD coatings are reported in Table 1.

Table 1. Material Properties of the Si₃N₄ Wafer (Measured by Nanoindentation) and the MCD Coating.⁸

| materials | Young's modulus (GPa) | Poisson's ratio | hardness (GPa) |
|--------------------------------------|-----------------------|-----------------|----------------|
| Si ₃ N ₄ wafer | 270 \pm 12 | 0.17 | 22.3 \pm 1.5 |
| MCD coating | 1000 \pm 200 | 0.07 | 90 \pm 10 |

The diamond-coated hemisphere is immobilized onto a nanoindenter (FT-I04, Femtotoools, see SI for more details) to perform the nonrepeated⁴⁰ wear experiment, in which each stroke takes place on a previously untouched region on the wafer (Figure 1). Our choice for nonrepeated wear is motivated by precision positioning applications in which wear-resistant materials are repeatedly contacted by fresh samples. The friction/wear experiment consists of 800 strokes of 20 μm sliding distance with a 70 mN load applied and an imposed sliding velocity of 2 $\mu\text{m/s}$. During each sliding cycle, the friction force is measured.

For imaging the MCD surface before and after the wear experiments as well as the scratches on the Si₃N₄ flat, an AFM (Dimension ICON, Bruker) was used in the tapping mode⁴¹ in an ambient environment.

For the computational study, the choice of using DFT over classical force fields stems from the fact that tribochemical processes involve bond breaking and forming, for which an accurate quantum-mechanical description of the electronic behavior of the system is paramount.

We approached the study in two steps. First, by means of AIMD simulations, we studied the dependence of diamond surface reactivity on the passivating species since the initial step of tribochemical wear necessarily involves the formation of chemical bonds across the

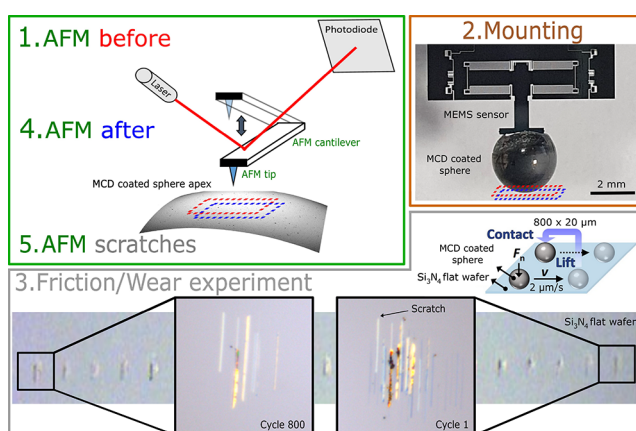


Figure 1. Imaging and friction/wear experiment. Green frame: we use atomic force microscopy (AFM) to image the MCD surface before and after the wear experiment as well as the scratches made on the Si₃N₄ wafer by the MCD coating during the friction/wear experiment. Brown frame: Photo of a SiC hemisphere coated with MCD and glued onto a MEMS sensor for the friction/wear experiment. The dashed blue and red rectangles in the green and brown frames indicate that AFM measurements on the hemisphere are centered on the apex that contacts the flat Si₃N₄ in the friction/wear experiment. Gray frame: A schematic representation of the nonrepeated wear experiment is depicted in the top-right corner of the frame. Optical microscopy images of the scratches made by the MCD coating on the Si₃N₄ flat indicate that as the experiment progresses, fewer scratches are visible.

diamond-Si₃N₄ interface. In the second step, through ab initio static calculations, we studied how likely certain bonding configurations between Si₃N₄ clusters and diamond are to cause atomistic wear by detaching carbon atoms from the surface.

In the AIMD simulations, the Si₃N₄-diamond interface was created using two slabs (periodic in the x - y plane), placing the diamond slab on top of the Si₃N₄ slab. The diamond slab consisted of 6×4 cells of the C(110) surface, with 7 carbon layers, and a lateral size of 15.13×14.27 Å. The amorphous Si₃N₄ slab was ≈ 12 Å thick, with the same lateral size as the diamond slab, and contained 227 atoms. A vacuum region of more than 10 Å was included above the diamond slab in the z -direction to suppress spurious interactions with periodic replicas. Due to the large size of the cells, it was sufficient to sample the Brillouin zone at the Γ -point. It is worth mentioning that the simulated systems contained up to 670 atoms, which is a considerable size in the context of AIMD simulations.

The tribological conditions of sliding under load were realized by imposing on the topmost diamond layer a normal load of 23 GPa, corresponding to the harsh conditions at which plowing friction occurs when the load exceeds the hardness of the Si₃N₄ substrate, and a constant speed in the x -direction to reproduce sliding. The positions of the atoms in a 4.5 Å-thick slice at the bottom of the Si₃N₄ slab were kept fixed to counterbalance the applied load. More details on the computational setup are reported in the Supporting Information.

RESULTS AND DISCUSSION

Diamond Wear Experiment. Figure 2a shows the MCD surface before the wear experiment that was conducted in an ambient environment. We zoomed-in to a single MCD asperity or crystallite and quantified the wear of that crystallite (Figure 2b). By plotting the height profile across the MCD crystallite before and after the wear experiment, we can quantify how the MCD surface changes during the wear experiment. Focusing on this wear of individual diamond crystallites, we see flattening of the sharp crystallite surface and can quantify the local height loss of up to 100 nm. Interestingly, considering

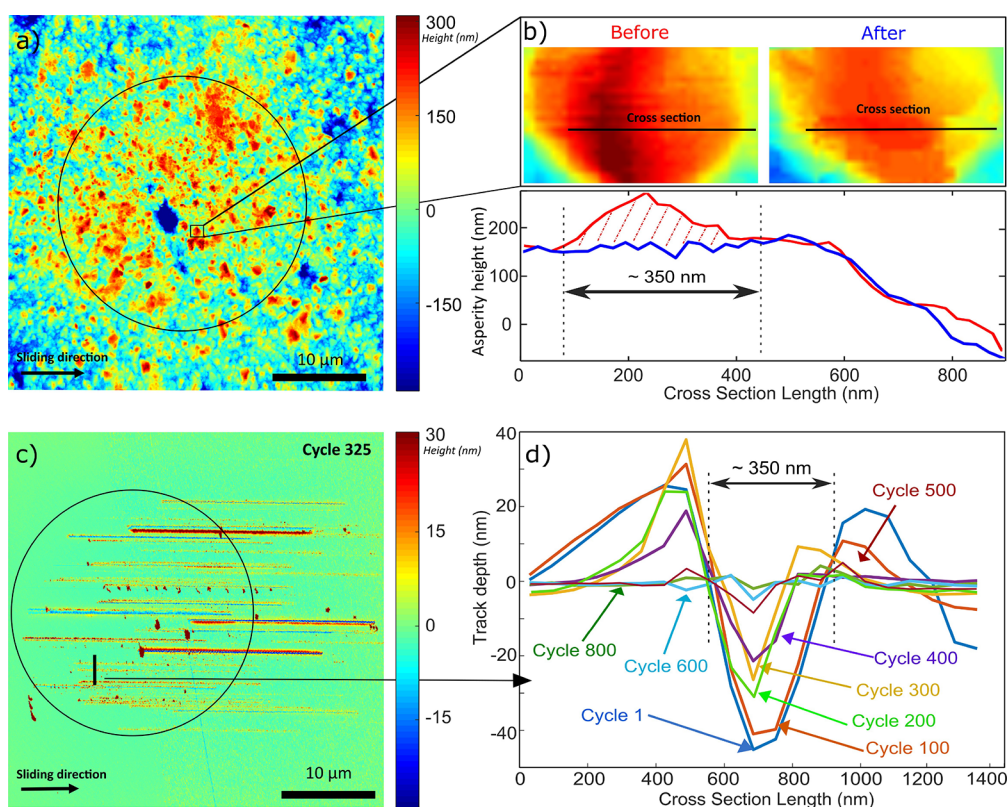


Figure 2. (a) AFM image of the MCD surface measured before the wear experiment in an ambient environment. The black circle represents the Hertzian contact area. (b) Zoom-in view of an MCD crystallite (top box) and plot of a height profile across the crystallite (bottom box) measured before (red) and after (blue) the wear experiment. More before and after images of the spheres are shown in Figure S3. (c) Scratches made by the MCD coating on the Si₃N₄ wafer in cycle 325, imaged by AFM (for more examples, see Figures S4 and S5). The circle represents the Hertzian contact area (average Hertzian pressure of 0.2 GPa) and encloses the starting point of all scratches. The contact pressure within the plowing asperity contacts is expected to be equal to the Si₃N₄ hardness of approximately 23 GPa. (d) Cross sections of the scratch indicated in (c), measured at various cycles of the wear experiment. The depth of the scratch and the pile-up of Si₃N₄ next to the scratch decrease as the experiment progresses, indicating that the diamond crystallite causing the scratch is wearing.

that this height loss may take place gradually during 800 strokes, this result is consistent with an atom-by-atom^{16,18,19} wear process, as only a single atomic layer would be removed from the diamond per cycle (20 μm of sliding).

AFM Imaging of Scratches. To get a better understanding of the evolution of the MCD surface throughout the experiment, we image the scratches left on the Si₃N₄ surface by the MCD. We want to emphasize that although Si₃N₄ wear is a relevant topic on its own,⁴² the main purpose behind imaging the scratches on the Si₃N₄ in this study is to obtain a quantitative understanding of the MCD wear. As shown in Figure 2c, the hard MCD crystallites plow^{43,44} through the softer Si₃N₄. Impressively, each cycle in the wear experiment results in a cluster of scratches on the Si₃N₄ surface that can be located and imaged as each sliding cycle is performed on a previously untouched part of the Si₃N₄ flat. The nonrepeated nature of the wear experiment thus results in scratches on the Si₃N₄ that can be linked to cycle numbers in the wear experiment. We interpret the scratches on Si₃N₄ as footprints of the diamond crystallites that cause the scratches. On and next to the scratches, we can also observe a significant amount of piled-up Si₃N₄ as well as Si₃N₄ particles. For the deepest scratches, the amount of piled-up Si₃N₄ is maximal, and the displaced Si₃N₄ partially covers the scratches, making measurement of the depth of the scratches challenging. To study the evolution of the depth of the scratches on Si₃N₄, we, therefore, select those scratches that are most clearly visible (Figure 2c).

In Figure 2d, we plot and align height profiles taken perpendicular to the sliding direction for the same scratch identified in subsequent cycles during the friction/wear experiment. This enables us to observe a decrease in the depth of the scratch as the cycle number increases. Importantly, this result supports the previous conjecture that the MCD crystallites wear gradually, although some variation in the rate at which the scratch depth decreases over the course of the experiment is visible. Figure 2d also shows that the cross-sectional area of the piled-up material on both sides of the scratch is approximately equal to the cross-sectional area of the scratch itself, indicating that the pile-up material is Si₃N₄. We thus argue that the decrease in the depth of the Si₃N₄ scratch indirectly reveals the gradual smoothing of the MCD crystallites plowing through the Si₃N₄ wafer in each stroke.

Quantifying Diamond Wear. To translate the evolving scratch profile from Figure 2d into a diamond wear rate,^{19,43,44} we assume that the diamond crystallites causing the scratches are cone-shaped. We then calculate the volume of these cone-shaped MCD crystallites for various cycles during the wear experiment based on the cross-sectional profiles of the scratches on the Si₃N₄. To obtain the MCD wear volume, we subtract the crystallite volumes calculated based on scratches that were made subsequent to one another. Furthermore, by dividing the resulting wear volume by the (average) area over which the MCD crystallite contacts the Si₃N₄ wafer, we obtain the average thickness of MCD that is

worn during the cycles that are covered by the calculation. For each environmental condition, we perform this analysis on two different Si_3N_4 scratches, selected based on the absence of substantial debris covering the scratches (Figures S4 and S5). These two scratches thus relate to two different MCD crystallites. We analyze each scratch based on three height profiles taken orthogonal to the sliding direction at different locations along the scratch. This analysis enables us to plot (Figure 3) the cumulative diamond thickness lost for an

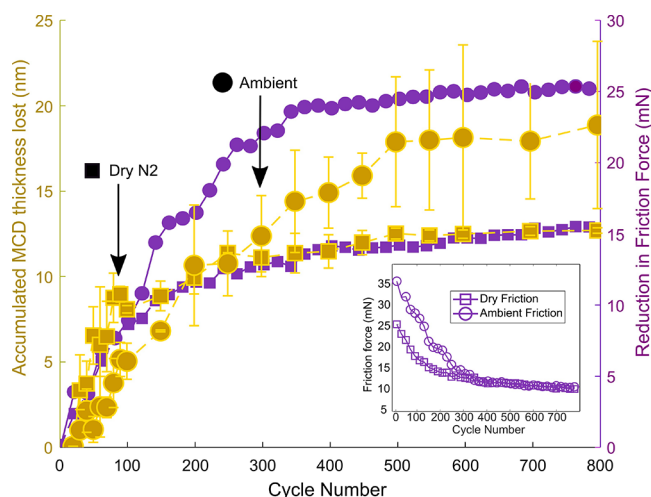


Figure 3. Accumulated diamond thickness lost and friction reduction versus cycle number. For both ambient and dry environments, the wear is strongly correlated to the change in friction. Inset: friction evolution of the system during the full experiment.

experiment performed in a dry nitrogen environment ($\text{RH} < 5\%$, squares) as well as an experiment performed in an ambient environment ($\text{RH} = 50\%$, circles). This analysis uniquely provides nanometer-scale insight into the diamond wear behavior throughout the 800 sliding cycles in the experiment.

The Si_3N_4 scratches are generated as long as the diamond crystallites plow through the Si_3N_4 wafer, exerting a pressure equal to the Si_3N_4 hardness. We, therefore, expect that the diamond wear rate, expressed as diamond volume lost per unit contact area per unit sliding distance, remains constant until the diamond asperities become smooth enough so as not to plow through the Si_3N_4 anymore. Indeed, we see that the cumulative diamond thickness lost for both the ambient and the dry nitrogen experiments increases at a nearly constant rate, after which a plateau value is reached after cycle 500 and cycle 200, respectively, for the experiments conducted in ambient and dry nitrogen environments. The MCD-coated hemisphere that was used in the ambient environment experiment made, on average, deeper scratches on the Si_3N_4 wafer, translating into higher plowing friction and more total diamond thickness lost (Figures S7 and S8). This difference between the diamond spheres leads to a crossover in the accumulated MCD thickness lost after about 200 cycles (Figure 3). We observe that for the first 90 cycles—where both the ambient and dry experiments display constant diamond wear rate—the cumulative diamond wear increases faster in the dry conditions than in the ambient environment.

Additional insight into the wear behavior is obtained by monitoring the dynamic friction force during wear experiments. As a pristine section on the Si_3N_4 flat is visited in each stroke, any changes in friction during the wear experiment are

caused by changes to the MCD-coated hemisphere. In Figure 3, we plot the reduction of the friction force with respect to its initial value alongside the wear data. Interestingly, the friction and the cumulative diamond thickness lost correlate well, supporting our wear analysis.

The observations described above confirm that plowing friction⁴⁵ dominates the tribological system; when the scratches on the Si_3N_4 wafer become too shallow to be measured, the friction force stabilizes. Friction and wear correlate well for both the experiment conducted in an ambient environment and the experiment conducted in dry N_2 ; the deeper scratches observed in the ambient environment experiment lead to higher initial friction and longer continuation of the steady-state wear process, compared to the experiment conducted in a dry nitrogen environment (more details in Supporting Information). A rough estimate of the plowing friction force can be obtained by multiplying the plowing cross section by the Si_3N_4 hardness. Assuming 30 scratches of width 300 nm and depth 50 nm (Figures 2, 4 and

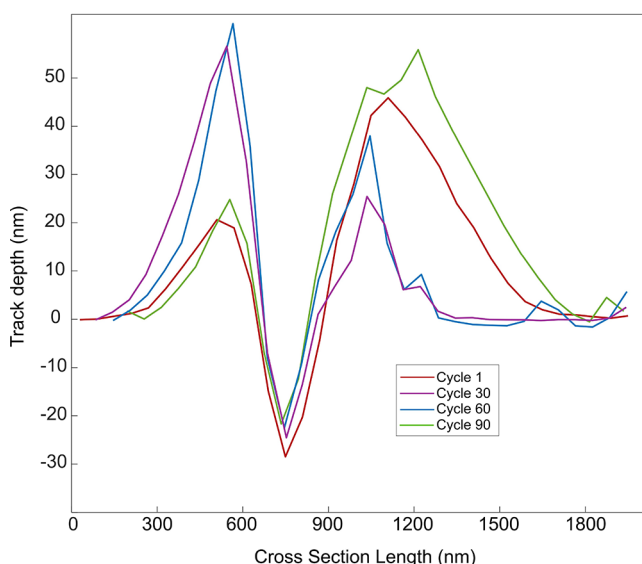


Figure 4. Evolution of the cross section of a scratch in the first 90 cycles of the ambient wear experiment.

Supporting Information), we get to a plowing force of 5 mN; the same order of magnitude as the observed reduction in friction in Figure 3. The good correlation of the wear and friction during run-in^{15,26,34,46} suggests that the friction signal can provide in situ information on the wear-induced evolution of the diamond topography. Indeed, the observed diamond run-in behavior, dominated by changes in interface topography, is reminiscent of that observed previously in various experiments.^{31,47,48}

Atom-by-Atom Wear. We now consider only the first 90 cycles of the wear experiment (Figures 4 and 5), in which a large number of diamond crystallites plow through Si_3N_4 for both the ambient and dry nitrogen experiments. We observe that, within the contact area, the cumulative thickness of diamond that gets worn off the surface scales approximately linearly with sliding distance. As the contact pressure within the plowing contacts should be constant, this result also indicates that wear scales with applied normal force. The wear rates we observe are very low, especially compared to those associated with atom cluster removal or plasticity.^{49,50} Our

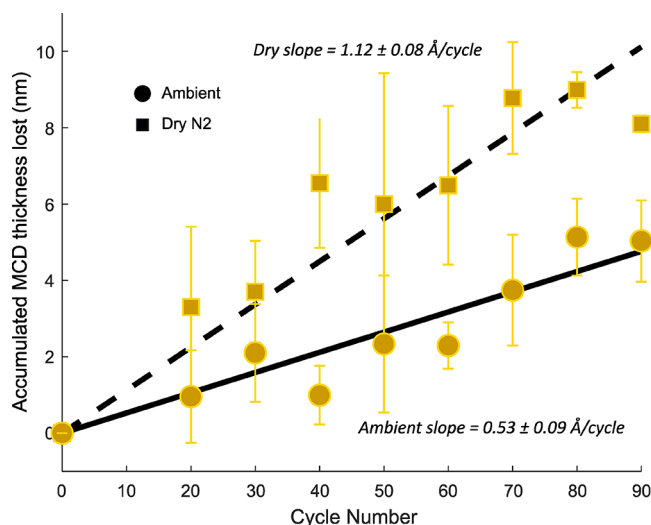


Figure 5. Diamond wear in the first 90 cycles of the wear experiment. The data are fitted with a linear function crossing the origin of the plot. Error bars represent the variation in diamond thickness lost found for two independent crystallites per environmental condition. For each crystallite/scratch, three cross sections along the scratch were used. The reported slope fits include 95% confidence intervals. More examples of evolving scratches are reported in Figures S4–S8.

analysis demonstrates that the amount of wear per cycle is consistent with an atom-by-atom wear process. A linear fit was applied to the data, which impressively shows diamond wear rates of only 1.12 ± 0.08 Å/cycle for the dry nitrogen experiment and 0.53 ± 0.09 Å/cycle for the ambient environment experiment. We found a factor 2 difference in the MCD wear rate depending on the availability of environmental passivation species. In our experiment, changing the relative humidity changes the thickness of the water layer present on both the MCD and the Si_3N_4 surfaces. Therefore, the reduction in relative humidity may significantly impact the coverage of passivating O, H, and OH species at the interface, as previously suggested by both experimental^{26,51} and theoretical^{52,53} studies. In order to provide an atomistic understanding of the interplay between environment and wear rate, we conduct first-principles density functional theory (DFT)⁵⁴ calculations that address the same system under the same contact conditions.

Molecular Dynamics Simulations. Due to the vastly different time scales between AIMD and experiment, our simulations target the chemistry underlying the observed wear rates. Rather than reproducing wear depth, we focus on how passivating groups influence bond formation at the diamond– Si_3N_4 interface, providing mechanistic insight into the experimentally observed suppression of wear under ambient conditions. In the AIMD simulations, we impose an interfacial normal stress of 23 GPa, set by the hardness of Si_3N_4 (Table 1). This choice is motivated by the experimental observation of plowing friction, which suggests that those diamond crystallites that indent and scratch the Si_3N_4 experience a normal interfacial stress equal to the hardness of Si_3N_4 (Figure S2). The results of our AIMD simulations (more details in the Methods and Supporting Information) for the variously terminated C(110) surface sliding against Si_3N_4 in different directions are presented in Figure 6. Just from visual inspection, it is already clear that the presence of passivating species strongly reduces the formation of bonds between

carbon atoms of diamond and Si/N atoms of the Si_3N_4 in the simulation without passivation species, representative of the dry N_2 environment, all surface carbon atoms are chemically bonded to Si_3N_4 , while the H+OH passivation, representative of the humid environment, visibly reduces the formation of C–N and C–Si bonds. Some bonds at the interface are still formed, mainly at the locations of hydroxyl groups, which form Si–O–C bonds after the transfer of their H atoms to Si_3N_4 . Moreover, as visible in Figure 6b,e, a few oxygen atoms themselves are transferred from diamond to Si_3N_4 and slowly migrate into the Si_3N_4 bulk, exposing the diamond surface to direct bonding with Si_3N_4 . On the other hand, hydrogen seems to be the most effective in hindering chemical bonding:⁵⁵ the H-passivated sites in the H+OH passivated surface are not involved in bonding throughout the entire simulation. This behavior is clearly demonstrated by the fully H-passivated diamond surface, which shows no bond formation, even when subjected to 23 GPa of contact pressure due to Pauli repulsion. We emphasize that H passivation is very stable under extreme conditions with no dissociation after 20 ps of sliding.

To make the comparison of various diamond surface terminations more quantitative, we analyze the simulation trajectories by calculating the interfacial distance between the diamond surface and Si_3N_4 , obtained as the difference between the average z-coordinates of the interfacial C atoms (upper slab) and Si/N atoms (lower slab). Furthermore, we calculate the friction force as the force opposing the sliding motion, measured as the sum of the x-component of the force on the topmost diamond layer, where the external load and sliding velocity constraints are applied. To make the graphs more readable, we filter fast oscillations in the forces with a moving average over 200 time steps. We then divide the forces by the area of the cell to obtain the interfacial shear stress (friction force per unit area). The trends of interfacial shear stress and sliding distance along the trajectories are reported in Figure 6g,f, for the perpendicular and parallel sliding directions, respectively, comparing the three different types of passivation. The nonpassivated surface (dry environment) shows the highest friction and lowest interfacial distance, due to the full chemical bonding at the interface. The H+OH passivation reduces the shear stress (by a small amount, 13.2 to 11.6 GPa, for the perpendicular direction and much more, 13.7 to 6.4 GPa, in the parallel sliding direction) and increases the interfacial distance by about 50% for both directions. The H-passivated surface shows a dramatic reduction in interfacial shear stress, since no chemical bonds need to be broken to enable slip; the friction force is only caused by Pauli repulsion between the hydrogen atoms on the diamond and the Si_3N_4 surface, which deforms under the diamond slab during sliding. For hydrogen-passivated diamond, the interfacial distance to the Si_3N_4 is larger than for the nonpassivated diamond, and it is similar to the interfacial distance observed for the H+OH passivation case. As the simulation progresses, the H-passivated surface maintains a constant interfacial distance, while the H+OH-passivated surface gets closer to the Si_3N_4 as the sliding progresses due to the loss of some OH groups. Indeed, the gradual replacement of OH passivation with H-passivation may occur in our wear experiments, as the experimental interfacial shear stresses are below 3.3 GPa, based on an upper limit for the normal stress of 23 GPa and an upper limit of the adhesive friction coefficient (in the absence of plowing) of 0.14 (Figure 3). These relatively low shear stresses and friction coefficients favor mild, atom-by-atom wear mechanisms over more severe

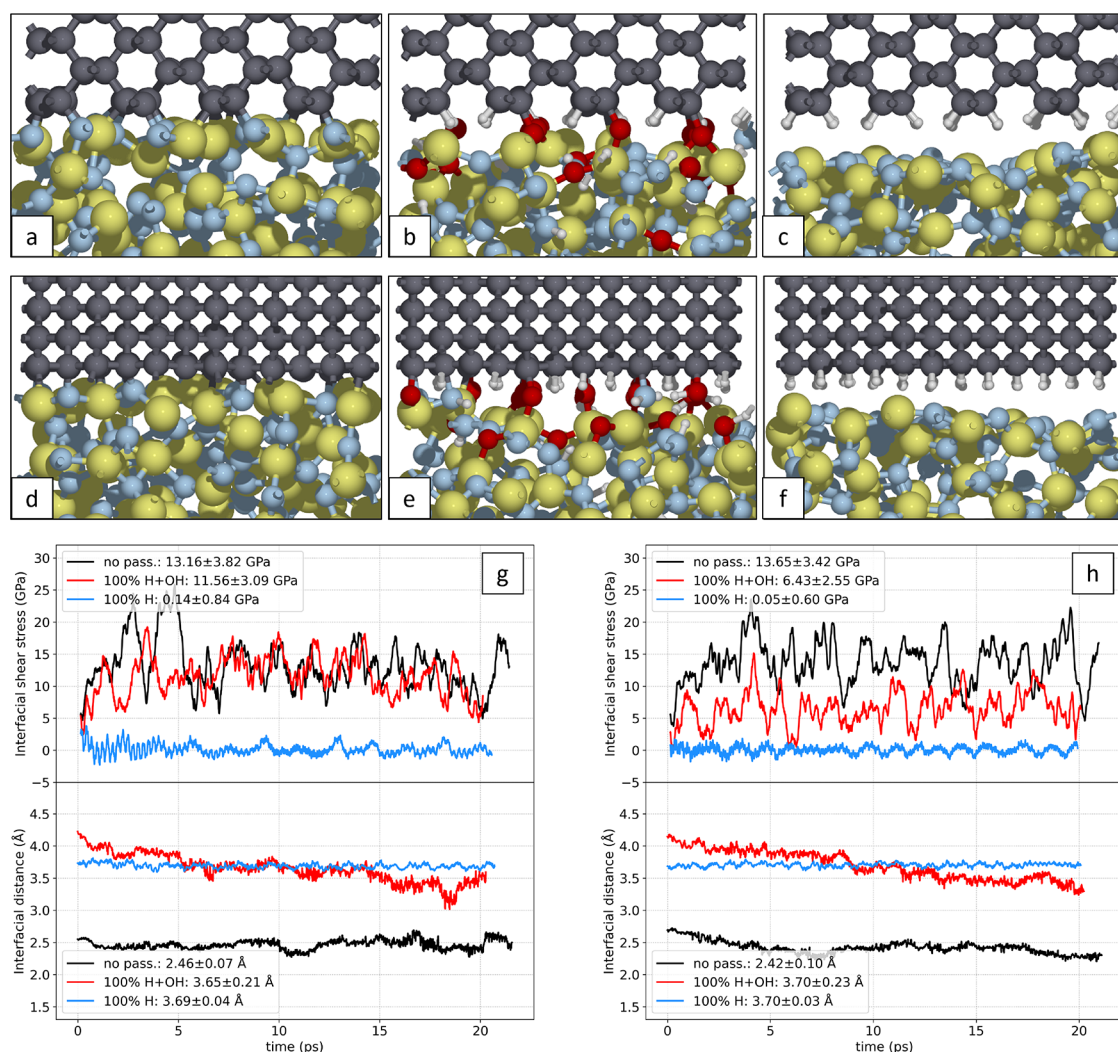


Figure 6. Snapshots of the C(110)—amorphous Si₃N₄ interface after 20 ps of AIMD simulation of sliding under applied contact pressure of 23 GPa. (a–c) refer to the sliding in the direction perpendicular to the zigzag chains of the C(110) surface for the different passivating species: no passivation, 100% H–OH passivation, and 100% H passivation of the diamond surface, respectively. (d–f) refer to sliding in the direction of the zigzag chains, for the same passivating species. Panels (g, h) show the interfacial shear stress (friction force per unit area) and the interfacial distance between diamond and Si₃N₄ for the sliding direction perpendicular and parallel to the zigzag chains, respectively. The color code of the atoms is as follows: gray for C, yellow for Si, blue for N, red for O, and white for H.

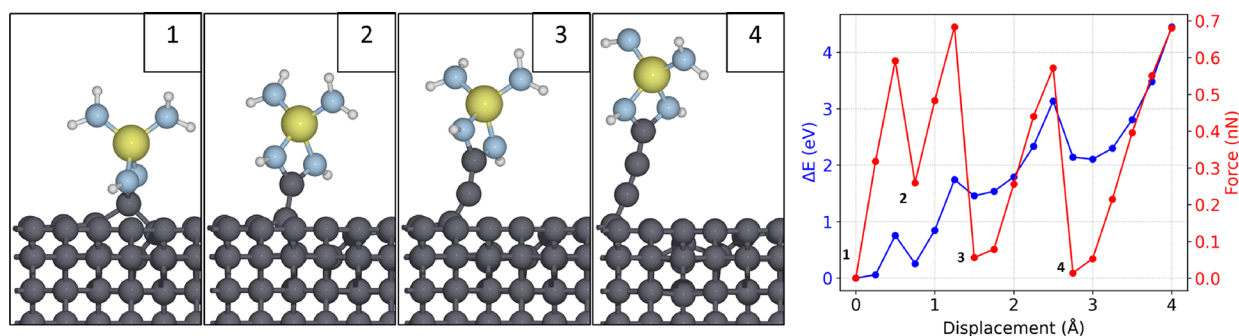


Figure 7. Wear mechanism of the C(110) surface by a small Si₃N₄ cluster initially bonded in a bidentate configuration. Starting from the initial configuration (1), the cluster is progressively pulled vertically by displacing the z coordinate of the central Si atom, measuring the force and the energy variation with respect to the starting point while the cluster is being pulled. Peaks in the force are followed by sudden drops (numbers 2, 3, and 4 in the graph) corresponding to the detachment of a carbon atom from the zigzag surface chain.

atom cluster removal or plasticity.³² A limitation in the comparison between experiment and simulation is that in the experiment, various diamond crystal faces interact with the

Si₃N₄ counter surface, while the presented simulations probe the reactive C(110) surface.

Table 2. Approximate Nonrepeated Wear Rates of the Harder (Left) Material in Ambient Environment,^{40,42,58} Including the Present Result for MCD

| materials | Si–Si | Si ₃ N ₄ –Si | SiC–Si | sapphire–Si | MCD–Si ₃ N ₄ |
|---------------------------------|----------------------|------------------------------------|----------------------|----------------------|------------------------------------|
| wear rate (mm ³ /Nm) | 5.2×10^{-4} | 1×10^{-4} | 7.7×10^{-6} | 6.5×10^{-6} | 1.2×10^{-7} |

The overall result, which emerges from this comparative analysis, is that passivating species coming from a humid environment are effective in protecting the diamond surface and preventing bonding to the Si₃N₄, which is the first step that enables atom-by-atom wear. Hydrogen, which is present only in water but not in dry N₂, is more effective than oxygen in passivating the diamond surface and suppressing interfacial bonding. This picture aligns qualitatively with our experimental findings. An increased interfacial distance due to passivation species (Figure 6g,h) bottom graphs) leads to fewer interfacial chemical bonds, thereby reducing atom-by-atom wear, as observed in our experiments.

To probe diamond wear more directly in the calculations, we evaluate the ability of various small Si₃N₄ clusters to pull carbon atoms out of the diamond matrix, starting from an initial bonding configuration (Figure 7). Among the Si₃N₄ clusters that we consider, the bidentate configuration, with two N atoms bonded to a carbon atom, is most effective in creating diamond wear. In the calculations, the central Si atom is in a tetrahedral configuration and is bonded to four N atoms, as in Si₃N₄, while N atoms are passivated with hydrogen to saturate dangling bonds. By vertically pulling the cluster from the central Si atom, we observe an initial small displacement of the bonded carbon atom of the zigzag chain of the C(110) surface. Increasing displacement of the cluster then results in progressive detachment of the whole zigzag carbon chain. The bond-breaking steps are reported in Figure 7, along with the energy variation as a function of displacement and the residual force on the Si atom at each step, which corresponds to the pulling force necessary to maintain the vertical position in each configuration. A force of ≈ 0.6 nN is reached before each carbon detachment, after which the force drops to a value close to zero, rising again as the next detachment approaches. This wear behavior of chain detachment initiated by bonds in a bidentate configuration is consistent with previous findings for silica^{56,25} and proves that chemical bonding can cause atomic-level wear of diamond, implying that the presence of passivating species that hinder bond formation can be effective in suppressing these atomic-scale wear processes.

DISCUSSION AND CONCLUSIONS

In summary, we studied MCD-on-Si₃N₄ friction and wear and found a low wear rate (\AA height loss per 20 μm sliding distance) of individual MCD crystallites within multi-asperity interfaces under harsh conditions, consistent with atom-by-atom wear of the MCD. It is important to note that while our AFM characterization of scratch profiles provides very detailed insight into the multi-asperity wear behavior, we cannot experimentally exclude the possibility that diamond wear events may involve larger clusters of atoms.^{49,50} Based on our data, an upper limit for the thickness of such clusters would be a few nanometers (Figures 4, 5 and S6). Our experiments represent a worst case scenario in terms of MCD wear because the high hardness of the Si₃N₄ wafer combined with the roughness of the MCD surface leads to contact pressures up to the hardness of Si₃N₄: 23 GPa. Indeed, silicon is known to display atom-by-atom wear at contact pressures equal to 20%

of its hardness.¹⁶ For the diamond contacts in this study, 23 GPa of normal stress corresponds to a similar fraction of the diamond hardness, suggesting that atom-by-atom wear is a likely scenario. The friction reduction in our study is strongly correlated with the wear of the MCD, highlighting that plowing gradually decreases as the MCD crystallites wear, such that the measured plowing friction forces indirectly provide information on the wear of the MCD. The present study is limited in the sense that we report in detail only on two independent experiments. However, more diamond-on-Si₃N₄ experiments have been conducted (see Supporting Information), confirming that the friction behavior is repeatable, and we will report on the influence of stroke length on the wear behavior in a future publication. Opposed to the constant (averaged) wear rate in the first 90 cycles of our experiments (Figure 5), we see some variation in the wear rate of an individual crystallite over the course of the full 800 cycle experiments (Figure 2d). We hypothesize that on these longer experimental time scales, diamond wear, variations in ball-on-flat alignment, and release of particles during plowing may influence the precise normal force distribution among the diamond crystallites, leading to complex asperity interactions;⁴² these effects could be studied in more detail in the future. Immersing the system in dry nitrogen to reduce the presence of passivating species, the wear of MCD accelerates by almost a factor 2 compared to the wear observed in ambient conditions; MCD wear increases from 0.53 ± 0.09 \AA /cycle in ambient to 1.12 ± 0.08 \AA /cycle in dry nitrogen. This result is qualitatively consistent with the known impact of environment on diamond friction.⁵⁷ To quantitatively place our wear rates in perspective, we translate into the unit mm³/Nm and compare to the nonrepeated wear of other material combinations in Table 2.

Furthermore, our results can be compared to previously measured diamond wear rates in reciprocal sliding experiments. At the macroscale, in DLC-on-Si₃N₄ sliding wear experiments, DLC wear rates ranging from 10^{-8} – 10^{-7} mm³/Nm have been reported.^{59–61} As MCD is harder than DLC, and therefore more difficult to wear, this comparison suggests that the nonrepeated nature of our experiments leads to higher wear rates, likely through the contact making-breaking steps and the reduced presence of third bodies.⁴⁰ At the nanoscale, higher wear rates for DLC and diamond-coated AFM probes sliding against silicon or Si₃N₄ are reported,^{13,15} ranging from 10^{-7} – 10^{-6} mm³/Nm. Our macroscale experiments result in a lower wear rate for MCD compared to nanoscale wear tests in the AFM. This may be attributed to the observation of fracture wear in AFM experiments due to the extreme aspect ratio of AFM probes, in contrast with the blunter MCD crystallites in our experiment.

Despite the harsh contact conditions in our experiment, the MCD wear rate is orders of magnitude lower than that of Si₃N₄, SiC, or sapphire sliding against silicon in ambient conditions, and also orders of magnitude lower than the rate at which diamond can be polished.⁶² Our results therefore quantify the widespread notion that diamond is extremely wear resistant, which has so far been challenging experimentally.⁶³

Through AIMD simulations, we argue that the contrast in wear behavior between ambient and dry conditions is controlled by surface passivation: dissociation of water in H and OH fragments can create a partial hydrogenation of the surface, which is key in suppressing chemical bonding across the MCD-Si₃N₄ interface and therefore reducing atomistic diamond wear. Our study uniquely connects atomic-scale simulations and macroscale tribological conditions, demonstrating that environmental control of surface chemistry can directly influence nanoscale wear in real interfaces. These findings offer a pathway for designing interfaces with tailored durability and provide a benchmark method for probing chemically driven wear mechanisms under practical conditions.

■ ASSOCIATED CONTENT

■ Supporting Information

The Supporting Information is available free of charge at <https://pubs.acs.org/doi/10.1021/acsami.5c08647>.

MCD on Si₃N₄ friction as a function of sliding distance; pre-post test MCD comparison (ambient experiment); plastic deformation of the Si₃N₄ wafer; AFM scans (50 μm by 50 μm) on the MCD coated balls before and after wear; AFM scans of the scratches left on the Si₃N₄ coated wafer at various cycles in the ambient and dry wear experiment; cross sections indirectly highlighting the evolution of a single diamond crystallite in the ambient experiment; 3D plots of the AFM data obtained on an individual scratch in subsequent strokes of the ambient and dry nitrogen wear experiment; radial pair distribution function (RDF) of bulk Si₃N₄ after quenching and at 6000K (NVT); and angle distribution of Si-N-Si and N-Si-N bonds (PDF)

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Notes

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■ REFERENCES

- (1) Jost, H. P. *Lubrication: Tribology; education and research; Report on the present position and industry's needs*; HM Stationery Office, 1966.
- (2) Holmberg, K.; Erdemir, A. Influence of tribology on global energy consumption, costs and emissions. *Friction* **2017**, *5*, 263–284.
- (3) Holmberg, K.; Erdemir, A. Global impact of friction on energy consumption, economy and environment. *FME Trans.* **2015**, *43*, 181–185.
- (4) Liu, J.; Grierson, D.; Moldovan, N.; Notbohm, J.; Li, S.; Jaroenapibal, P.; O'Connor, S.; Sumant, A.; Neelakantan, N.; Carlisle, J.; Turner, K. T.; Carpick, R. W. Preventing nanoscale wear of atomic force microscopy tips through the use of monolithic ultrananocrystalline diamond probes. *Small* **2010**, *6*, 1140–1149.
- (5) Wheeler, D. W. Applications of diamond to improve tribological performance in the oil and gas industry. *Lubricants* **2018**, *6*, 84.
- (6) Araujo, D.; Suzuki, M.; Lloret, F.; Alba, G.; Villar, P. Diamond for electronics: Materials, processing and devices. *Mater.* **2021**, *14*, 7081.
- (7) Hainsworth, S. V.; Uhure, N. Diamond like carbon coatings for tribology: production techniques, characterisation methods and applications. *Int. Mater. Rev.* **2007**, *52*, 153–174.
- (8) Auciello, O.; Aslam, D. M. Review on advances in microcrystalline, nanocrystalline and ultrananocrystalline diamond films-based micro/nano-electromechanical systems technologies. *J. Mater. Sci.* **2021**, *56*, 7171–7230.
- (9) Erdemir, A.; Donnet, C. Tribology of diamond-like carbon films: recent progress and future prospects. *J. Phys. D: Appl. Phys.* **2006**, *39*, R311.
- (10) Cutini, M.; Forghieri, G.; Ferrario, M.; Righi, M. C. Adhesion, friction and tribochemical reactions at the diamond–silica interface. *Carbon* **2023**, *203*, 601–610.
- (11) Peguiron, A.; Moras, G.; Walter, M.; Uetsuka, H.; Pastewka, L.; Moseler, M. Activation and mechanochemical breaking of c–c bonds

initiate wear of diamond (110) surfaces in contact with silica. *Carbon* **2016**, *98*, 474–483.

(12) Bhamra, J. S.; Ewen, J. P.; Latorre, C. A.; Bomidi, J. A.; Bird, M. W.; Dini, D. Atomic-scale insights into the tribochemical wear of diamond on quartz surfaces. *Appl. Surf. Sci.* **2023**, *639*, No. 158152.

(13) Bhaskaran, H.; Gotsmann, B.; Sebastian, A.; Drechsler, U.; Lantz, M. A.; Despont, M.; Jaroenapibal, P.; Carpick, R. W.; Chen, Y.; Sridharan, K. Ultralow nanoscale wear through atom-by-atom attrition in silicon-containing diamond-like carbon. *Nat. Nanotechnol.* **2010**, *5*, 181–185.

(14) Liang, J. H.; Milne, Z.; Rouhani, M.; Lin, Y.-P.; Bernal, R. A.; Sato, T.; Carpick, R. W.; Jeng, Y. R. Stress-dependent adhesion and sliding-induced nanoscale wear of diamond-like carbon studied using in situ TEM nanoindentation. *Carbon* **2022**, *193*, 230–241.

(15) Chung, K.-H.; Kim, D.-E. Wear characteristics of diamond-coated atomic force microscope probe. *Ultramicroscopy* **2007**, *108*, 1–10.

(16) Jacobs, T. D.; Carpick, R. W. Nanoscale wear as a stress-assisted chemical reaction. *Nat. Nanotechnol.* **2013**, *8*, 108–112.

(17) Gotsmann, B.; Lantz, M. A. Atomistic wear in a single asperity sliding contact. *Phys. Rev. Lett.* **2008**, *101*, No. 125501.

(18) Spikes, H. Stress-augmented thermal activation: Tribology feels the force. *Friction* **2018**, *6*, 1–31.

(19) Mate, C. M.; Carpick, R. W. *Tribology on the small scale: a modern textbook on friction, lubrication, and wear*; Oxford graduate texts, **2019**.

(20) Xiao, C.; Guo, J.; Zhang, P.; Chen, C.; Chen, L.; Qian, L. Effect of crystal plane orientation on tribochemical removal of monocrystalline silicon. *Sci. Rep.* **2017**, *7*, 40750.

(21) Wang, Y.; Xu, J.; Ootani, Y.; Ozawa, N.; Adachi, K.; Kubo, M. Non-empirical law for nanoscale atom-by-atom wear. *Adv. Sci.* **2021**, *8*, 2002827.

(22) Lin, Q.; Chen, S.; Ji, Z.; Huang, Z.; Zhang, Z.; Shen, B. High-temperature wear behavior of micro-and ultrananocrystalline diamond films against titanium alloy. *Surf. Coat. Technol.* **2021**, *422*, No. 127537.

(23) Peeters, S.; Kuwahara, T.; Härtwig, F.; Makowski, S.; Weihnacht, V.; Lasagni, A. F.; Dienwiebel, M.; Moseler, M.; Moras, G. Surface depassivation via B–O dative bonds affects the friction performance of B-doped carbon coatings. *ACS Appl. Mater. Interfaces* **2024**, *16*, 18112–18123.

(24) Mangolini, F.; Koshigan, K. D.; Van Benthem, M. H.; Ohlhausen, J. A.; McClimon, J. B.; Hilbert, J.; Fontaine, J.; Carpick, R. W. How hydrogen and oxygen vapor affect the tribochemistry of silicon- and oxygen-containing hydrogenated amorphous carbon under low-friction conditions: A study combining X-ray absorption spectromicroscopy and data science methods. *ACS Appl. Mater. Interfaces* **2021**, *13*, 12610–12621.

(25) Ta, H. T. T.; Tran, N. V.; Righi, M. C. Nanotribological properties of oxidized diamond/silica interfaces: Insights into the atomistic mechanisms of wear and friction by ab initio molecular dynamics simulations. *ACS Appl. Nano Mater.* **2023**, *6*, 16674–16683.

(26) Konicek, A.; Grierson, D.; Sumant, A.; Friedmann, T.; Sullivan, J.; Gilbert, P.; Sawyer, W.; Carpick, R. Influence of surface passivation on the friction and wear behavior of ultrananocrystalline diamond and tetrahedral amorphous carbon thin films. *Phys. Rev. B Condens.* **2012**, *85*, No. 155448.

(27) Pastewka, L.; Moser, S.; Gumbsch, P.; Moseler, M. Anisotropic mechanical amorphization drives wear in diamond. *Nat. Mater.* **2011**, *10*, 34–38.

(28) Moras, G.; Klemenz, A.; Reichenbach, T.; Gola, A.; Uetsuka, H.; Moseler, M.; Pastewka, L. Shear melting of silicon and diamond and the disappearance of the polymorphic transition under shear. *Phys. Rev. Mater.* **2018**, *2*, No. 083601.

(29) Liu, N.; Lei, L.; Lu, H.; Jiang, H.; Zhang, Y.; Xiao, J.; Zhang, J.; Chen, X.; Xu, J. C–C bond rupture initiated graphitization achieves highly efficient diamond polishing. *Int. J. Mech. Sci.* **2025**, *287*, No. 109958.

(30) Jang, S.; Rabbani, M.; Ogrinc, A. L.; Wetherington, M. T.; Martini, A.; Kim, S. H. Tribochemistry of diamond-like carbon: Interplay between hydrogen content in the film and oxidative gas in the environment. *ACS Appl. Mater. Interfaces* **2023**, *15*, 37997–38007.

(31) Wang, X.; Zhang, J.; Shen, B.; Zhang, T.; Sun, F. Fracture and solid particle erosion of micro-crystalline, nano-crystalline and boron-doped diamond films. *Int. J. Refract. Met. Hard Mater.* **2014**, *45*, 31–40.

(32) Aghababaei, R.; Warner, D. H.; Molinari, J.-F. Critical length scale controls adhesive wear mechanisms. *Nat. Commun.* **2016**, *7*, 11816.

(33) Devin, L. M.; Lytvyn, P. M.; Ivakhnenko, O. S.; Zanevskyi, O. O. Methodology for studying brittle fracture of hthp diamond single crystals by crack propagation analysis under shock load. *J. Superhard Mater.* **2024**, *46*, 14–22.

(34) Bernal, R. A.; Carpick, R. W. Visualization of nanoscale wear mechanisms in ultrananocrystalline diamond by in-situ TEM tribometry. *Carbon* **2019**, *154*, 132–139.

(35) Boing, D.; Navalles Martinez, E.; Norgren, S.; Hardell, J. Attrition wear in polycrystalline diamond cutting tools during interaction with aluminium. *Wear* **2025**, *571*, No. 205781.

(36) Kim, K.-H.; Moldovan, N.; Ke, C.; Espinosa, H. D.; Xiao, X.; Carlisle, J. A.; Auciello, O. Novel ultrananocrystalline diamond probes for high-resolution low-wear nanolithographic techniques. *Small* **2005**, *1*, 866–874.

(37) Burris, D.; Sawyer, G. Measurement uncertainties in wear rates. *Tribol. Lett.* **2009**, *36*, 81–87.

(38) Mueser, M.; Nicola, L. Modeling the surface topography dependence of friction, adhesion, and contact compliance. *MRS Bull.* **2022**, *47*, 1221–1228.

(39) Leriche, C.; Franklin, S.; Weber, B. Measuring multi-asperity wear with nanoscale precision. *Wear* **2022**, *498*, No. 204284.

(40) Hsia, F.-C.; Elam, F. M.; Bonn, D.; Weber, B.; Franklin, S. E. Wear particle dynamics drive the difference between repeated and non-repeated reciprocated sliding. *Tribol. Int.* **2020**, *142*, No. 105983.

(41) San Paulo, A.; Garcia, R. Unifying theory of tapping-mode atomic-force microscopy. *Phys. Rev. B* **2002**, *66*, No. 041406.

(42) Leriche, C.; Xiao, C.; Franklin, S.; Weber, B. From atomic attrition to mild wear at multi-asperity interfaces: The wear of hard Si₃N₄ repeatedly contacted against soft Si. *Wear* **2023**, *528–529*, No. 204975.

(43) Zum Gahr, K.-H. Wear by hard particles. *Tribol. Int.* **1998**, *31*, 587–596.

(44) Hokkirigawa, K.; Kato, K. An experimental and theoretical investigation of ploughing, cutting and wedge formation during abrasive wear. *Tribol. Int.* **1988**, *21*, 51–57.

(45) Song, H.; Dikken, R. J.; Nicola, L.; van der Giessen, E. Plastic ploughing of a sinusoidal asperity on a rough surface. *J. Appl. Mech.* **2015**, *82*, No. 071006.

(46) Konicek, A. R.; Grierson, D.; Gilbert, P.; Sawyer, W.; Sumant, A.; Carpick, R. W. Origin of ultralow friction and wear in ultrananocrystalline diamond. *Phys. Rev. Lett.* **2008**, *100*, No. 235502.

(47) Erdemir, A.; Fenske, G.; Krauss, A.; Gruen, D.; McCauley, T.; Csencsits, R. Tribological properties of nanocrystalline diamond films. *Surf. Coat. Technol.* **1999**, *120*, 565–572.

(48) Uchida, M.; Liu, H.; Iwabuchi, A.; Yamamoto, K. Effects of water environment on tribological properties of DLC rubbed against stainless steel. *Wear* **2007**, *263*, 1335–1340.

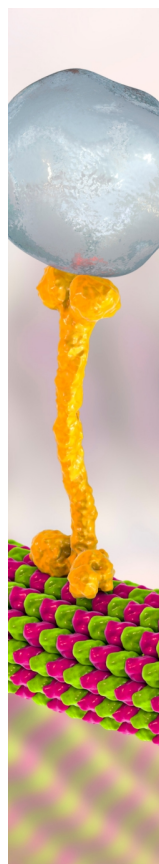
(49) Zhao, K.; Aghababaei, R. Adhesive wear law at the single asperity level. *J. Mech. Phys. Solids* **2020**, *143*, No. 104069.

(50) Zhao, K.; Aghababaei, R. Interfacial plasticity controls material removal rate during adhesive sliding contact. *Phys. Rev. Materials* **2020**, *4*, No. 103605.

(51) Peng, L.; Hsu, C.-C.; Xiao, C.; Bonn, D.; Weber, B. Controlling macroscopic friction through interfacial siloxane bonding. *Phys. Rev. Lett.* **2023**, *131*, No. 226201.

(52) Zilibotti, G.; Corni, S.; Righi, M. C. Load-induced confinement activates diamond lubrication by water. *Phys. Rev. Lett.* **2013**, *111*, No. 146101.

- (53) Tran, N. V.; Righi, M. C. Ab initio insights into the interaction mechanisms between H₂, H₂O, and O₂ molecules with diamond surfaces. *Carbon* **2022**, 199, 497–507.
- (54) Hohenberg, P.; Kohn, W. Inhomogeneous electron gas. *Phys. Rev.* **1964**, 136, B864.
- (55) Milne, Z. B.; Schall, J. D.; Jacobs, T. D.; Harrison, J. A.; Carpick, R. W. Covalent bonding and atomic-level plasticity increase adhesion in silicon–diamond nanocontacts. *ACS Appl. Mater. Interfaces* **2019**, 11, 40734–40748.
- (56) Ta, H. T.; Tran, N. V.; Righi, M. C. Atomistic wear mechanisms in diamond: Effects of surface orientation, stress, and interaction with adsorbed molecules. *Langmuir* **2023**, 39, 14396–14403.
- (57) Erdemir, A.; Martin, J. M. Superior wear resistance of diamond and DLC coatings. *Curr. Opin. Solid State Mater. Sci.* **2018**, 22, 243–254.
- (58) Hsia, F.-C.; Hsu, C.-C.; Peng, L.; Elam, F. M.; Xiao, C.; Franklin, S.; Bonn, D.; Weber, B. Contribution of capillary adhesion to friction at macroscopic solid–solid interfaces. *Phys. Rev. Appl.* **2022**, 17, No. 034034.
- (59) Bares, J. A.; Sumant, A. V.; Grierson, D. S.; Carpick, R. W.; Sridharan, K. Small amplitude reciprocating wear performance of diamond-like carbon films: dependence of film composition and counterface material. *Tribol. Lett.* **2007**, 27, 79–88.
- (60) Jia, K.; Li, Y. Q.; Fischer, T. E.; Gallois, B. Tribology of diamond-like carbon sliding against itself, silicon nitride, and steel. *J. Mater. Res.* **1995**, 10, 1403–1410.
- (61) Kim, D. S.; Fischer, T. E.; Gallois, B. The effects of oxygen and humidity on friction and wear of diamond-like carbon films. *Surf. Coat. Technol.* **1991**, 49, 537–542.
- (62) Yang, N.; Zong, W.; Li, Z.; Sun, T. Wear process of single crystal diamond affected by sliding velocity and contact pressure in mechanical polishing. *Diamond Relat. Mater.* **2015**, 58, 46–53.
- (63) Hayward, I.; Singer, I.; Seitzman, L. Effect of roughness on the friction of diamond on cvd diamond coatings. *Wear* **1992**, 157, 215–227.



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